

X3-Class HiPerFET™ **Power MOSFET**

IXFT120N30X3HV **IXFH120N30X3**

300V 120A $11.0 m\Omega$

N-Channel Enhancement Mode Avalanche Rated

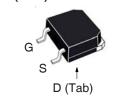


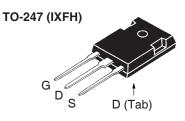
Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_J = 25^{\circ}C$ to $150^{\circ}C$	300	V	
V _{DGR}	$T_{_{\mathrm{J}}} = 25^{\circ}\mathrm{C}$ to $150^{\circ}\mathrm{C}$, $R_{_{\mathrm{GS}}} = 1\mathrm{M}\Omega$	300	V	
V _{GSS}	Continuous	±20	V	
V _{GSM}	Transient	±30	V	
I _{D25}	$T_{\rm c} = 25^{\circ}{\rm C}$ $T_{\rm c} = 25^{\circ}{\rm C}$, Pulse Width Limited by $T_{\rm JM}$	120 280	A A	
I _A	T _C = 25°C	60	Α	
E _{AS}	$T_{\rm C} = 25^{\circ}{\rm C}$	2	J	
dv/dt	$I_{S} \leq I_{DM}, V_{DD} \leq V_{DSS}, T_{J} \leq 150^{\circ}C$	20	V/ns	
P_{D}	T _C = 25°C	735	W	
T _J		-55 +150	°C	
T _{JM}		150	°C	
T _{stg}		-55 +150	°C	
T _L	Maximum Lead Temperature for Soldering	300	°C	
T _{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C	
M _d	Mounting Torque (TO-247)	1.13 / 10	Nm/lb.in	
Weight	TO-268HV TO-247	4 6	g g	

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V _{DSS}	$T_J = 25^{\circ}C \text{ to } 150^{\circ}C$	300	V	
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I _{D25}	$T_{\rm C} = 25^{\circ}{\rm C}$ $T_{\rm C} = 25^{\circ}{\rm C}$, Pulse Width Limited by $T_{\rm JM}$	120 280	A A	
IA	T _C = 25°C	60	А	
E _{AS}	$T_{c} = 25^{\circ}C$	2	J	
dv/dt	$I_{_{\mathrm{S}}} \le I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \le V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \le 150^{\circ}\mathrm{C}$	20	V/ns	
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		teristic Values Typ. Max.		
BV _{DSS}	$V_{GS} = 0V, I_D = 1mA$	300		\
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 4mA$	2.5		4.5
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100 nA
l _{DSS}	$V_{DS} = V_{DSS}$, $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			25 μA 1 mA
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \bullet I_{D25}, Note 1$		8.6	11.0 m2

TO-268HV (IXFT)





G = Gate D = Drain S = SourceTab = Drain

Features

- International Standard Packages
- Low $R_{DS(ON)}$ and Q_G Avalanche Rated
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- · Robotics and Servo Controls



Symbol Test Conditions Char		acteristic Values		
$(T_J = 25^{\circ}C, Unless Otherwise Specified)$ Min.		Тур.	Max	
g _{fs}	$V_{DS} = 10V, I_{D} = 60A, Note 1$	60	100	S
R _{Gi}	Gate Input Resistance		1.7	Ω
C _{iss}			10.5	nF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		1376	pF
C _{rss}			3	pF
	Effective Output Capacitance			
$C_{o(er)}$	Energy related $\int V_{GS} = 0V$		530	pF
$C_{o(tr)}$	Time related $\int V_{DS}^{GS} = 0.8 \cdot V_{DSS}$		2100	pF
t _{d(on)}	Resistive Switching Times		30	ns
t _r	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		30	ns
t _{d(off)}	$R_{\rm GS} = 3\Omega$ (External)		130	ns
t,	n _G = 352 (External)		14	ns
$Q_{g(on)}$			170	nC
Q_{gs}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		50	nC
Q _{gd}			50	nC
R _{thJC}				0.17 °C/W
R _{thCS}	TO-247		0.21	°C/W

Source-Drain Diode

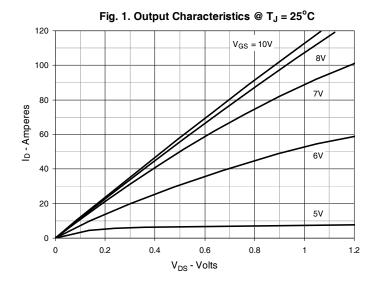
			acteristic Values		
$(1_{J} = 25^{\circ}C, C)$	oniess Otherwise Specified)	Min.	Тур.	Max	
Is	$V_{GS} = 0V$			120	Α
SM	Repetitive, pulse Width Limited by $T_{_{JM}}$			480	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.4	V
$\left\{egin{array}{c} \mathbf{t}_{rr} & \\ \mathbf{Q}_{RM} & \\ \mathbf{I}_{RM} & \end{array} ight\}$	$I_F = 60A$, $-di/dt = 100A/\mu s$ $V_R = 100V$		145 930 13		ns nC A

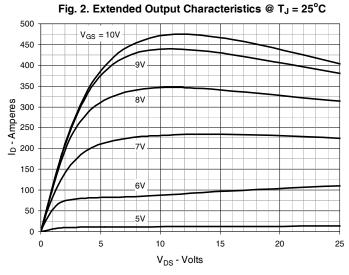
Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

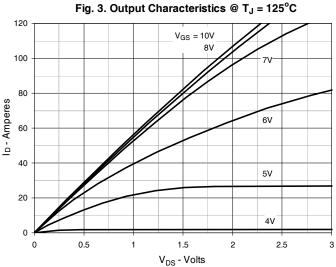
ADVANCE TECHNICAL INFORMATION

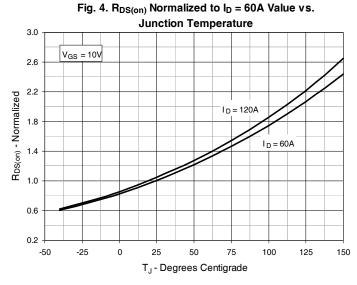
The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

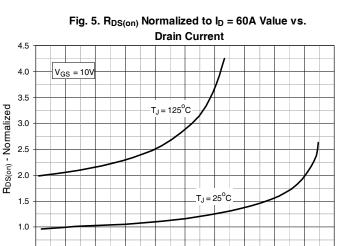


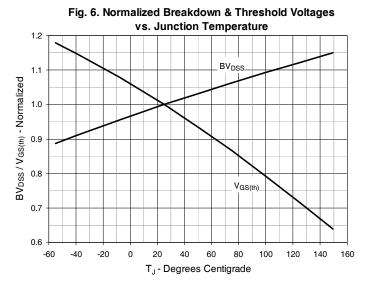






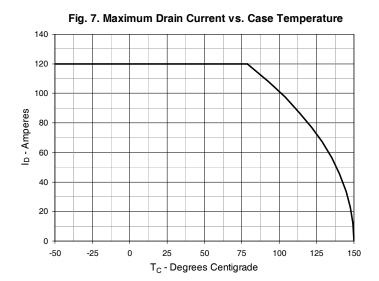


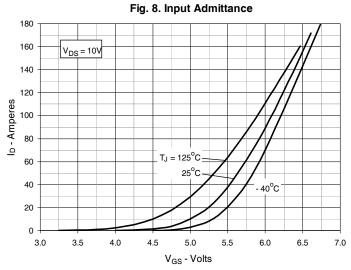


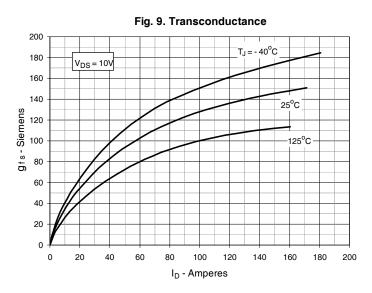


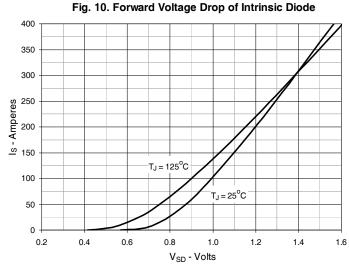
I_D - Amperes

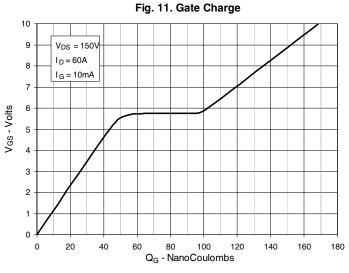


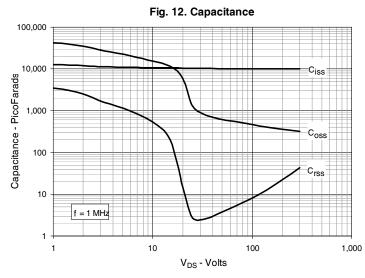






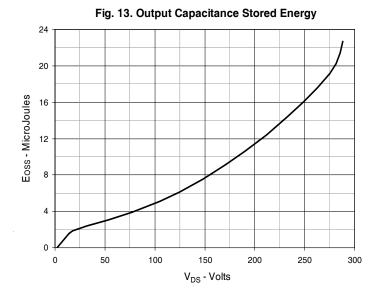






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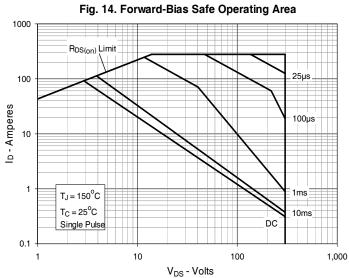
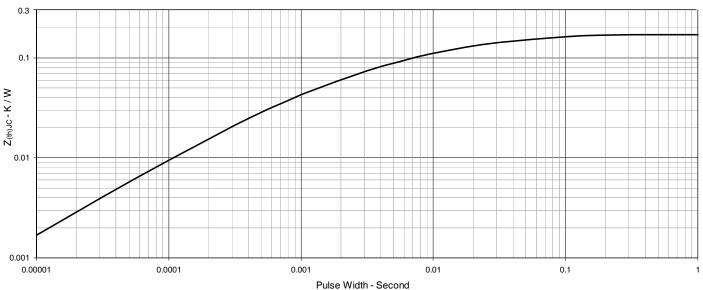
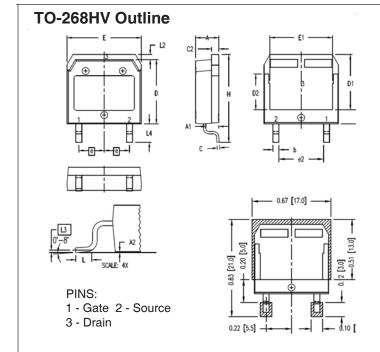


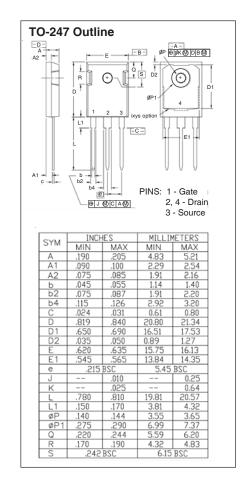
Fig. 15. Maximum Transient Thermal Impedance







SYM	INCHES		MILLIMETER	
STM	MIN	MAX	MIN	MAX
Α	.193	.201	4.90	5.10
Α1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
Ь	.045	.057	1.15	1.45
С	.016	.026	0.40	0.65
<u>C2</u>	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.465	.476	11.80	12.10
D2	.295	.307	7.50	7.80
D3	.114	.126	2.90	3.20
Ē	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
е	.215	BSC	5. 4 5 BSC	
(e2)	.374	.386	9.50	9.80
Н	.736	.752	18.70	19.10
L	.067	.079	1.70	2.00
L2	.039	.045	1.00	1.15
L3	.010	BSC	0.25 BSC	
L4	.150	.161	3.80	4 .10



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